

#### NCE N-Channel Enhancement Mode Power MOSFET

## **Description**

The NCE01H13D uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

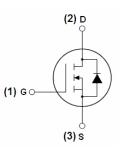
- $V_{DS} = 100V, I_D = 130A$  $R_{DS(ON)} < 6.8 m\Omega @ V_{GS} = 10V$  (Typ:5.3 m $\Omega$ )
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

## **Application**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-263-2L top view

## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01H13D	NCE01H13D	TO-263-2L	-	-	-

# Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	130	Α
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	92	Α
Pulsed Drain Current	I <sub>DM</sub>	520	Α
Maximum Power Dissipation	P <sub>D</sub>	285	W
Derating factor		1.9	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	1100	mJ
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 175	$^{\circ}$





# **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 2)	R <sub>eJC</sub>	0.53	°C/W	
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Electrical Characteristics (T<sub>c</sub>=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100	110	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	5.3	6.8	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	40	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C <sub>lss</sub>		-	6979.8	-	PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =50V, $V_{GS}$ =0V,	-	414.6	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	321.3	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	31	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =50V, $R_L$ =2.5 $\Omega$	-	24	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{GEN}$ =3 $\Omega$	-	45	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	27	-	nS
Total Gate Charge	Qg	\/ F0\/ L 00A	-	178	-	nC
Gate-Source Charge	$Q_{gs}$	$V_{DS}$ =50V, $I_D$ =20A, $V_{GS}$ =10V	-	41.9	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	72.6	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	$V_{SD}$	V <sub>GS</sub> =0V,I <sub>S</sub> =40A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	130	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF =20A	-	65	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	110	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is neg	igible (tur	n-on is do	minated by	y LS+LD)

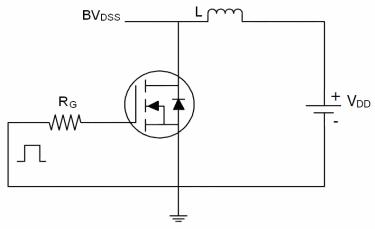
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production 5. EAS condition: $Tj=25^{\circ}\text{C}$ , $V_{DD}=50V$ , $V_{G}=10V$ ,L=1mH, $Rg=25\Omega$

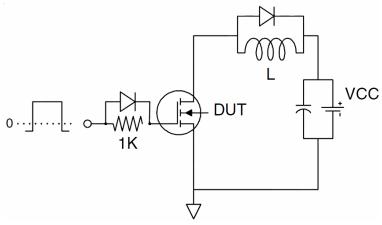


## **Test Circuit**

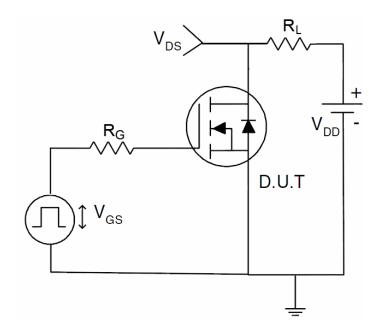
# 1) E<sub>AS</sub> test Circuit



# 2) Gate charge test Circuit

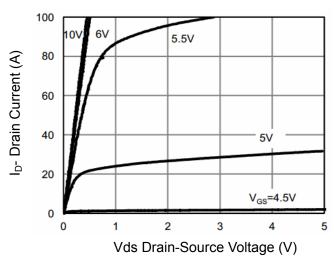


# 3) Switch Time Test Circuit

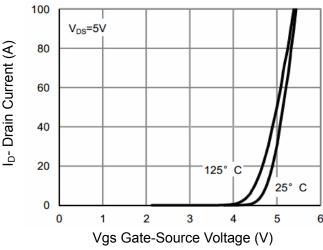




# Typical Electrical and Thermal Characteristics (Curves



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

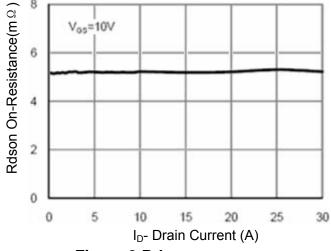


Figure 3 Rdson- Drain Current

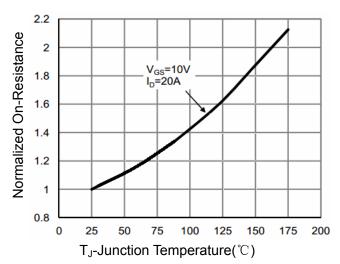


Figure 4 Rdson-JunctionTemperature

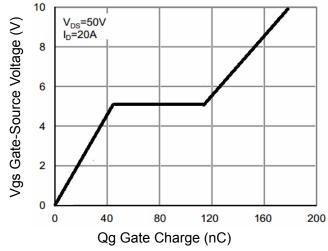


Figure 5 Gate Charge

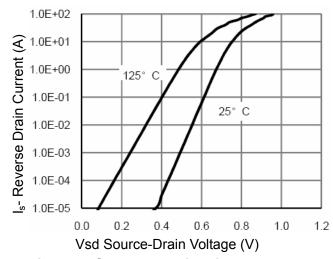


Figure 6 Source- Drain Diode Forward



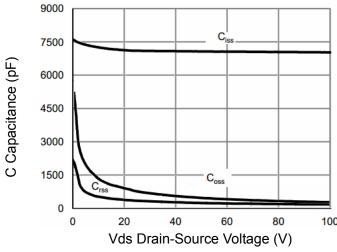


Figure 7 Capacitance vs Vds

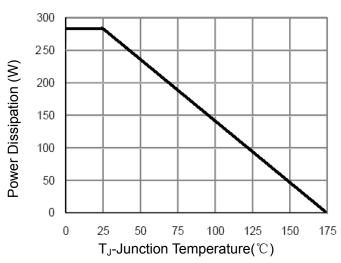


Figure 9 Power De-rating

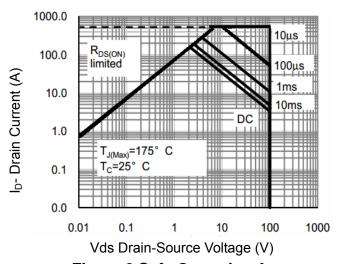
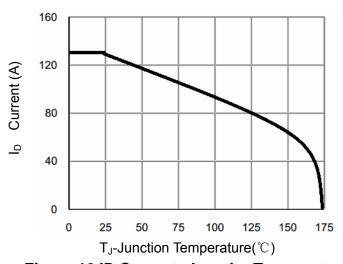
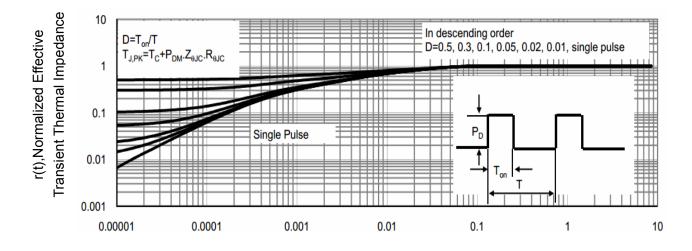


Figure 8 Safe Operation Area



**Figure 10 ID Current- JunctionTemperature** 

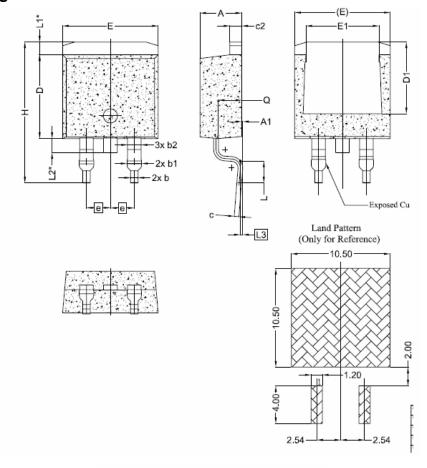


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



# **TO-263-2L Package Information**



SYMBOL	DIMENSIONS				
STIVIBOL	MIN.	NOM.	MAX.		
Α	4.24	4.44	4.64		
A1	0.00	0.10	0.25		
b	0.70	0.80	0.90		
b1	1.20	1.55	1.75		
b2	1,20	1,45	1,70		
С	0.40	0.50	0.60		
c2	1,15	1,27	1,40		
D	8.82	8.92	9.02		
D1	6.86	7.65	_		
Е	9.96	10.16	10.36		
E1	6.89	7.77	7.89		
е	2.54 BSC				
Н	14,61	15,00	15,88		
L	1.78	2.32	2.79		
L1	1.36 REF.				
L2	1.50 REF.				
L3	0.25 BSC				
Q	2.30 2.48 2.70				



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